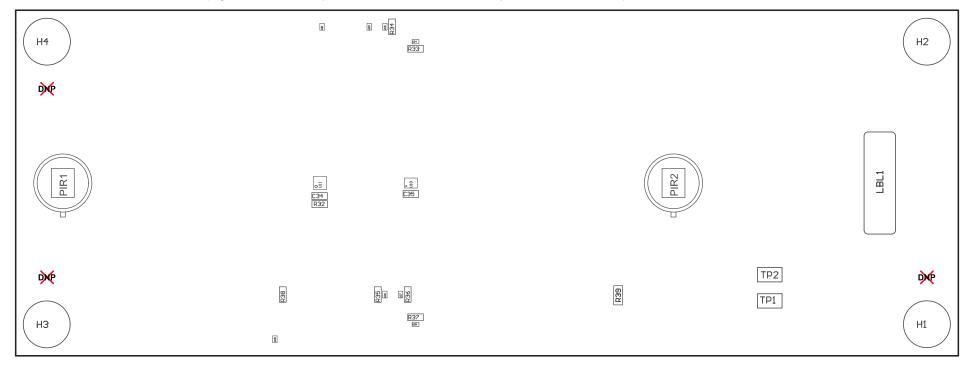
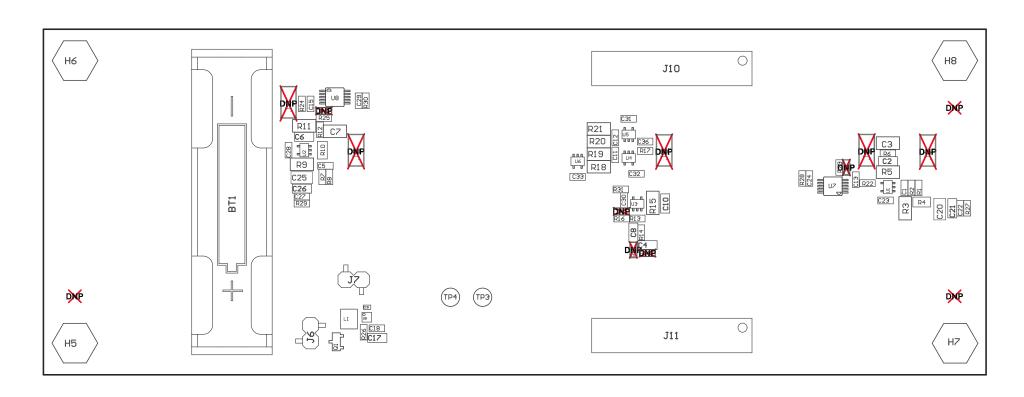
- ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZZ ■These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01069 REV: E1	SVN REV: Not In VersionControl
	TID #: 01069	
PLOT NAME = Top Assembly Drawing	GENERATED : 28/02/2017 11:10:50	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01069 REV: E1	SVN REU: Not In VersionControl
	TID #: 01069	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 28/02/2017 11:10:	TEXAS INSTRUMENTS

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